

## EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1	(substrate same semiconductor same laser same waveguide same first same second same electrode same insulating same adhesive same wiring).clm.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/08/25 15:39
S1	10	((("5402436") or ("5355382") or ("4901325") or ("20020053872") or ("20020142503")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/03/12 19:26
S2	1366	372/50.1.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:36
S3	280	372/50.12.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:36
S4	88	372/50.121.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:36
S5	352	S2 and ((semiconductor diode) same ((first same second) top\$4) same electrode)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:38
S6	5	S2 and ((semiconductor diode) same ((first same second) top\$4) same electrode same Flip\$8)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:39
S7	1	S3 and ((semiconductor diode) same ((first same second)) same electrode same Flip\$8)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:41

S8	0	S4 and ((semiconductor diode) same ((first same second)) same electrode same Flip\$8)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:41
S9	0	S1 and ((semiconductor diode) same ((first same second)) same electrode same Flip\$8)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:42
S10	0	S1 and ((semiconductor diode) same ((first same second)) same electrode same Flip\$10)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/12 19:42
S11	63	laser same ((semiconductor diode) same ((first same second)) same electrode same Flip\$10)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/13 13:52
S12	45	laser same ((semiconductor diode) same two same electrode same Flip\$10)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/13 14:07
S13	313	laser same ((semiconductor diode) same packag\$3 same Flip \$10)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 15:25
S14	12	laser same ((semiconductor diode) same packag\$3 same Flip \$10) same adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 15:27
S15	135	laser same ((semiconductor diode) same packag\$3 same Flip \$10) same bond\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 15:29
S16	2	"5385632".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 15:52
S17	24	laser same ((semiconductor diode) same packag\$3 same Flip \$10) same first same second	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 15:53

S18	72	laser same ((semiconductor diode) same packag\$3 same Flip \$10) same active	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 15:55
S19	920	substrate same ((semiconductor diode) same packag\$3 same Flip \$10) same (active waveguide)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:01
S20	0	substrate same ((semiconductor diode) same packag\$3 same Flip \$10) same (active waveguide) same bobd\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:01
S21	637	substrate same ((semiconductor diode) same packag\$3 same Flip \$10) same (active waveguide) same bond\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:01
S22	148	substrate same ((semiconductor diode) same packag\$3 same Flip \$10) same (active waveguide) same bond\$3 same (insulat\$3 adhesive epoxy)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:02
S23	0	laser same ((semiconductor diode) same packag\$3 same Flip \$10) same bond\$3 same sog	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:25
S24	0	laser same ((semiconductor diode) same Flip\$10) same bond \$3 same sog	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:26
S25	16	laser same (semiconductor diode) same bond\$3 same sog	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:26
S26	105	laser same (semiconductor diode) same sog	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:28
S27	3	laser same (semiconductor diode) same sog same adhesive	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/14 16:28

S28	2	"4901325".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/03/15 11:11
-----	---	---------------	---	----	----	---------------------

8/25/08 3:40:18 PM

C:\Documents and Settings\dnguyen20\My Documents\EAST\Workspaces\10576925.wsp